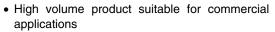




Lead (Pb)-free Commodity Thick Film Chip Resistors



FEATURES





- Pure tin solder contacts on Ni barrier layer provides compatibility with lead (Pb)-free and lead containing soldering processes
- · Metal glaze on high quality ceramic
- Compliant to RoHS Directive 2002/95/EC
- Halogen-free according to IEC 61249-2-21 definition

STANDARD ELECTRICAL SPECIFICATIONS								
	SIZE		RATED	LIMITING	TEMPERATURE		RESISTANCE	
MODEL	INCH	METRIC	DISSIPATION P _{70 °C} W	VOLTAGE Umax. AC/DC	COEFFICIENT ppm/K	TOLERANCE %	RANGE Ω	SERIES
CRCW0201	0201	RR 0603M	0.05		± 100	± 1	47R to 1M0	E24; E96
				30	± 200	± 1 ± 5	10R to 1M0	E24; E96 E24
			Zero-Ohm-Resistor: $R_{\text{max.}} = 50 \text{ m}\Omega$, $I_{\text{max.}}$ at 70 °C = 1.0 A					

Notes

- These resistors do not feature a limited lifetime when operated within the permissible limits. However, resistance value drift increasing over
 operating time may result in exceeding a limit acceptable to the specific application, thereby establishing a functional lifetime.
- · Power rating depends on the max. temperature at the solder point, the component placement density and the substrate material.

TECHNICAL SPECIFICATIONS					
PARAMETER	UNIT	CRCW0201			
Rated dissipation P_{70} ⁽¹⁾	W	0.05			
Limiting element voltage $U_{\rm max.}$ AC/DC	V	30			
Insulation voltage U_{ins} (1 min)	V	50			
Insulation resistance	Ω	> 109			
Category temperature range	°C	- 55 to + 155			
Weight	mg	0.17			

Note

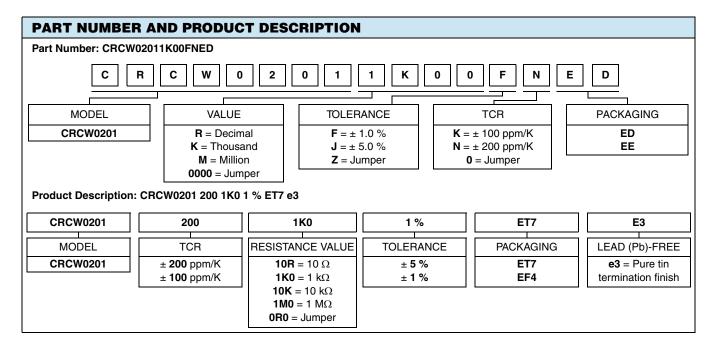
(1) The power dissipation on the resistor generates a temperature rise against the local ambient, depending on the heat flow support of the printed-circuit board (thermal resistance). The rated dissipation applies only if the permitted film temperature of 155 °C is not exceeded.

Document Number: 20052 Revision: 08-Mar-11

Vishay

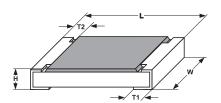
Lead (Pb)-free Commodity Thick Film Chip Resistors

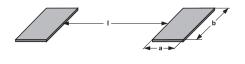




PACKAGING						
MODEL	UNIT	PAPER TAPE ON REEL ACC. TO IEC 60286-3, TYPE I				
		QUANTITY	PART NUMBER	PRODUCT DESC.		
CDCW0201	180 mm/7"	10 000	ED	ET7		
CRCW0201	330 mm/13"	50 000	EE	EF4		

DIMENSIONS in millimeters





SIZE		DIMENSIONS					SOLDER PAD DIMENSIONS		
SIZE		DIMENSIONS					REFLOW SOLDERING		
INCH	METRIC	L	W	Н	T1	T2	а	b	I
0201	0603	0.6 ± 0.05	0.3 ± 0.05	0.23 ± 0.05	0.15 ± 0.05	0.15 + 0.05 - 0.10	0.28	0.43	0.23

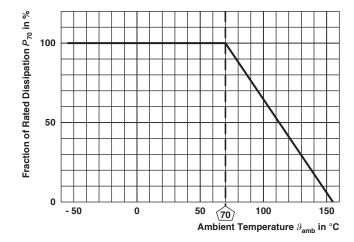
Note

· No marking for 0201 size



Lead (Pb)-free Commodity Thick Film Chip Resistors

DERATING



TEST F	TEST PROCEDURES AND REQUIREMENTS							
EN 60115-1 CLAUSE	IEC 60068-2 TEST METHOD	TEST	PROCEDURE	REQUIREMENTS PERMISSIBLE CHANGE (Δ <i>R</i>)				
			Stability for product types:					
			CRCW0201 e3	10 Ω to 1 M Ω				
4.5	-	Resistance	-	± 1 %; ± 5 %				
4.7	-	Voltage proof	$U = 1.4 \times U_{ins}$; 60 s	No flashover or breakdown				
4.13	-	Short time overload	$U = 2.5 \times \sqrt{P_{70} \times R}$ $\leq 2 \times U_{\text{max}};$ duration: 0.5 s	± (1 % <i>R</i> + 0.05 Ω)				
4.17.0		Coldorability	Solder bath method; Sn60Pb40 non activated flux; (235 ± 5) °C (2 ± 0.2) s	Good tinning (≥ 95 % covered) no visible damage				
4.17.2 58 (58 (Td)	Solderability	Solder bath method; Sn96.5Ag3Cu0.5 non-activated flux; (245 ± 5) °C (3 ± 0.3) s	Good tinning (≥ 95 % covered) no visible damage				
4.8.4.2	-	Temperature coefficient	(20/- 55/20) °C and (20/125/20) °C	± 100 ppm/K, ± 200 ppm/K				
4.32	21 (Uu ₃)	Shear (adhesion)	9 N	No visible damage				
4.33	21 (Uu ₁)	Substrate bending	Depth 2 mm; 3 times	No visible damage, no open circuit in bent position $\pm (0.5~\%~R + 0.05~\Omega)$				
4.19	14 (Na)	Rapid change of	30 min. at - 55 °C; 30 min. at 125 °C					
7.10	17 (Να)	temperature	5 cycles	$\pm (0.5 \% R + 0.05 \Omega)$				
			1000 cycles	± (1 % R + 0.05 Ω)				

Lead (Pb)-free Commodity Thick Film Chip Resistors



TEST F	TEST PROCEDURES AND REQUIREMENTS							
EN 60115-1 CLAUSE	IEC 60068-2 TEST METHOD	TEST	PROCEDURE	REQUIREMENTS PERMISSIBLE CHANGE (Δ <i>R</i>)				
	'		Stability for product types:					
			CRCW0201 e3	10 Ω to 1 M Ω				
4.23	-	Climatic sequence:	-					
4.23.2	2 (Ba)	Dry heat	125 °C; 16 h					
4.23.3	30 (Db)	Damp heat, cyclic	55 °C; ≥ 90 % RH; 24 h; 1 cycle					
4.23.4	1 (Aa)	Cold	- 55 °C; 2 h	± (2 % R + 0.1 Ω)				
4.23.5	13 (M)	Low air pressure	1 kPa; (25 ± 10) °C; 1 h					
4.23.6	30 (Db)	Damp heat, cyclic	55 °C; ≥ 90 % RH; 24 h; 5 cycles					
4.23.7	-	DC load	$U = \sqrt{P_{70} \times R}$					
4.25.1		Endurance at 70 °C	$U = \sqrt{P_{70} \times R} \le U_{\text{max}};$ 1.5 h on; 0.5 h off;					
4.25.1	-		70 °C; 1000 h	± (2 % R + 0.1 Ω)				
			70 °C; 8000 h	± (4 % R + 0.1 Ω)				
4.18.2	58 (Td)	Resistance to soldering heat	Solder bath method (260 ± 5) °C; (10 ± 1) s	± (1 % R + 0.05 Ω)				
4.35	-	Flamability, needle flame test	IEC 60695-11-5; 10 s	No burning after 30 s				
4.24	78 (Cab)	Damp heat, steady state	(40 ± 2) °C; (93 ± 3) % RH; 56 days	± (2 % R + 0.1 Ω)				
4.25.3	-	Endurance at upper category temperature	155 °C, 1000 h	± (2 % R + 0.1 Ω)				
4.29	45 (XA)	Component solvent resistance	Isopropyl alcohol; 50 °C; method 2	No visible damage				
4.22	6 (Fc)	Vibration, endurance by sweeping	$f = 10 \text{ Hz to } 2000 \text{ Hz}; \\ x, y, z \le 1.5 \text{ mm}; \\ A \le 200 \text{ m/s}^2; \\ 10 \text{ sweeps per axis}$	± (0.5 % R + 0.05 Ω)				

All tests are carried out in accordance with the following specifications:

- EN 60115-1, generic specification
- EN 140400, sectional specification
- EN 140401-802, detail specification
- IEC 60068-2-x, environmental test procedures

Packaging of components is done in paper tapes according to IEC 60286-3.

Document Number: 20052 Revision: 08-Mar-11





Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and/or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk and agree to fully indemnify and hold Vishay and its distributors harmless from and against any and all claims, liabilities, expenses and damages arising or resulting in connection with such use or sale, including attorneys fees, even if such claim alleges that Vishay or its distributor was negligent regarding the design or manufacture of the part. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

Revision: 11-Mar-11